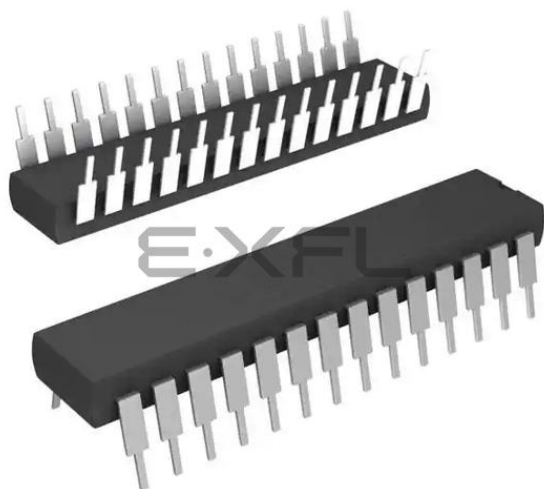




Welcome to E-XFL.COM

What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Obsolete
Core Processor	eZ8
Core Size	8-Bit
Speed	20MHz
Connectivity	IrDA, UART/USART
Peripherals	Brown-out Detect/Reset, LED, LVD, POR, PWM, WDT
Number of I/O	25
Program Memory Size	8KB (8K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	1K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Through Hole
Package / Case	28-DIP (0.600", 15.24mm)
Supplier Device Package	-
Purchase URL	https://www.e-xfl.com/product-detail/zilog/z8f081apj020ec

Table of Contents

Overview	1
Features	1
Part Selection Guide	2
Block Diagram	4
CPU and Peripheral Overview	5
eZ8 CPU Features	5
10-Bit Analog-to-Digital Converter	5
Low-Power Operational Amplifier	6
Internal Precision Oscillator	6
Temperature Sensor	6
Analog Comparator	6
External Crystal Oscillator	6
Low Voltage Detector	6
On-Chip Debugger	6
Universal Asynchronous Receiver/Transmitter	7
Timers	7
General-Purpose Input/Output	7
Direct LED Drive	7
Flash Controller	7
Non-Volatile Data Storage	7
Interrupt Controller	8
Reset Controller	8
Pin Description	9
Available Packages	9
Pin Configurations	9
Signal Descriptions	11
Pin Characteristics	13
Address Space	15
Register File	15
Program Memory	15
Data Memory	17
Flash Information Area	17
Register Map	19

Table 1. Z8 Encore! XP[®] F082A Series Family Part Selection Guide

Part Number	Flash (KB)	RAM (B)	NVDS¹ (B)	I/O	Comparator	Advanced Analog²	ADC Inputs	Packages
Z8F082A	8	1024	0	6–23	Yes	Yes	4–8	8-, 20- and 28-pin
Z8F081A	8	1024	0	6–25	Yes	No	0	8-, 20- and 28-pin
Z8F042A	4	1024	128	6–23	Yes	Yes	4–8	8-, 20- and 28-pin
Z8F041A	4	1024	128	6–25	Yes	No	0	8-, 20- and 28-pin
Z8F022A	2	512	64	6–23	Yes	Yes	4–8	8-, 20- and 28-pin
Z8F021A	2	512	64	6–25	Yes	No	0	8-, 20- and 28-pin
Z8F012A	1	256	16	6–23	Yes	Yes	4–8	8-, 20- and 28-pin
Z8F011A	1	256	16	6–25	Yes	No	0	8-, 20- and 28-pin

¹Non-volatile data storage.

²Advanced Analog includes ADC, temperature sensor, and low-power operational amplifier.

Block Diagram

Figure 1 displays the block diagram of the architecture of the Z8 Encore! XP[®] F082A Series devices.

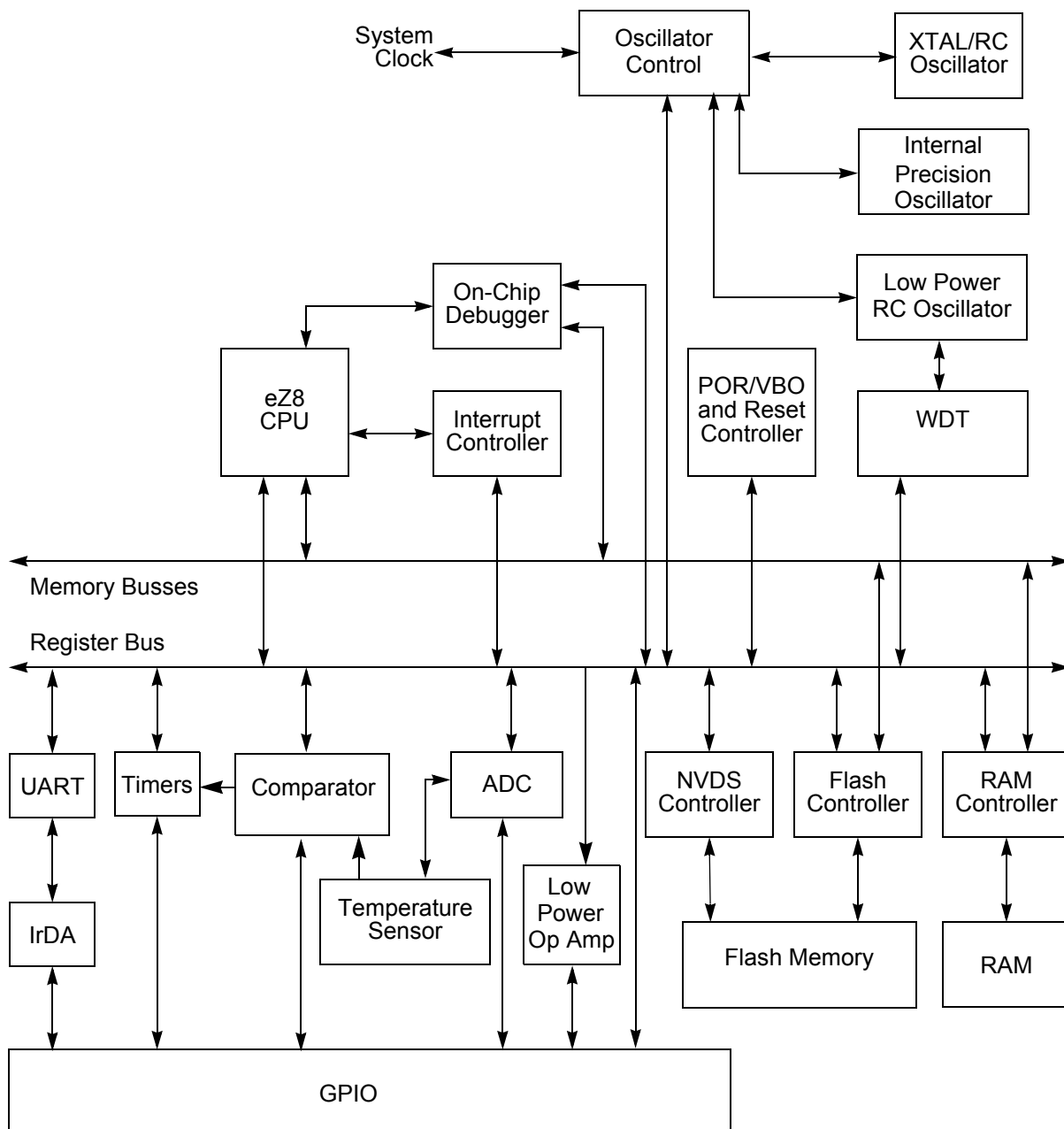


Figure 1. Z8 Encore! XP F082A Series Block Diagram

Table 2. Signal Descriptions (Continued)

Signal Mnemonic	I/O	Description
Power Supply		
V _{DD}	I	Digital Power Supply.
AV _{DD}	I	Analog Power Supply.
V _{SS}	I	Digital Ground.
AV _{SS}	I	Analog Ground.
Note: The AV _{DD} and AV _{SS} signals are available only in 28-pin packages with ADC. They are replaced by PB6 and PB7 on 28-pin packages without ADC.		

Pin Characteristics

Table 3 describes the characteristics for each pin available on the Z8 Encore! XP F082A Series 20- and 28-pin devices. Data in Table 3 is sorted alphabetically by the pin symbol mnemonic.

Table 4 on page 14 provides detailed information about the characteristics for each pin available on the Z8 Encore! XP F082A Series 8-pin devices.

► **Note:** All six I/O pins on the 8-pin packages are 5 V-tolerant (unless the pull-up devices are enabled). The column in Table 3 below describes 5 V-tolerance for the 20- and 28-pin packages only.

Table 3. Pin Characteristics (20- and 28-pin Devices)

Symbol Mnemonic	Direction	Reset Direction	Active Low or Active High	Tristate Output	Internal Pull-up or Pull-down	Schmitt-Trigger Input	Open Drain Output	5 V Tolerance
AVDD	N/A	N/A	N/A	N/A	N/A	N/A	N/A	N/A
AVSS	N/A	N/A	N/A	N/A	N/A	N/A	N/A	NA
DBG	I/O	I	N/A	Yes	Yes	Yes	Yes	No
PA[7:0]	I/O	I	N/A	Yes	Programmable Pull-up	Yes	Yes, Programmable	PA[7:2] unless pullups enabled
PB[7:0]	I/O	I	N/A	Yes	Programmable Pull-up	Yes	Yes, Programmable	PB[7:6] unless pullups enabled

HALT Mode

Executing the eZ8 CPU's HALT instruction places the device into HALT mode, which powers down the CPU but leaves all other peripherals active. In HALT mode, the operating characteristics are:

- Primary oscillator is enabled and continues to operate.
- System clock is enabled and continues to operate.
- eZ8 CPU is stopped.
- Program counter (PC) stops incrementing.
- Watchdog Timer's internal RC oscillator continues to operate.
- If enabled, the Watchdog Timer continues to operate.
- All other on-chip peripherals continue to operate, if enabled.

The eZ8 CPU can be brought out of HALT mode by any of the following operations:

- Interrupt
- Watchdog Timer time-out (interrupt or reset)
- Power-On Reset
- Voltage Brownout reset
- External $\overline{\text{RESET}}$ pin assertion

To minimize current in HALT mode, all GPIO pins that are configured as inputs must be driven to one of the supply rails (V_{CC} or GND).

Peripheral-Level Power Control

In addition to the STOP and HALT modes, it is possible to disable each peripheral on each of the Z8 Encore! XP F082A Series devices. Disabling a given peripheral minimizes its power consumption.

Power Control Register Definitions

The following sections define the Power Control registers.

Power Control Register 0

Each bit of the following registers disables a peripheral block, either by gating its system clock input or by removing power from the block. The default state of the low-power

Reserved—Must be 0.

C3ENL—Port C3 Interrupt Request Enable Low Bit

C2ENL—Port C2 Interrupt Request Enable Low Bit

C1ENL—Port C1 Interrupt Request Enable Low Bit

C0ENL—Port C0 Interrupt Request Enable Low Bit

Interrupt Edge Select Register

The Interrupt Edge Select (IRQES) register ([Table 45](#)) determines whether an interrupt is generated for the rising edge or falling edge on the selected GPIO Port A input pin.

Table 45. Interrupt Edge Select Register (IRQES)

BITS	7	6	5	4	3	2	1	0
FIELD	IES7	IES6	IES5	IES4	IES3	IES2	IES1	IES0
RESET	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
ADDR	FCDH							

IES_x—Interrupt Edge Select *x*

0 = An interrupt request is generated on the falling edge of the PA_x input.

1 = An interrupt request is generated on the rising edge of the PA_x input.

where *x* indicates the specific GPIO Port pin number (0 through 7).

Shared Interrupt Select Register

The Shared Interrupt Select (IRQSS) register ([Table 46](#)) determines the source of the PAD_xS interrupts. The Shared Interrupt Select register selects between Port A and alternate sources for the individual interrupts.

Because these shared interrupts are edge-triggered, it is possible to generate an interrupt just by switching from one shared source to another. For this reason, an interrupt must be disabled before switching between sources.

Watchdog Timer

The Watchdog Timer (WDT) protects against corrupt or unreliable software, power faults, and other system-level problems which may place the Z8 Encore! XP[®] F082A Series devices into unsuitable operating states. The features of Watchdog Timer include:

- On-chip RC oscillator.
- A selectable time-out response: reset or interrupt.
- 24-bit programmable time-out value.

Operation

The Watchdog Timer is a one-shot timer that resets or interrupts the Z8 Encore! XP F082A Series devices when the WDT reaches its terminal count. The Watchdog Timer uses a dedicated on-chip RC oscillator as its clock source. The Watchdog Timer operates in only two modes: ON and OFF. Once enabled, it always counts and must be refreshed to prevent a time-out. Perform an enable by executing the WDT instruction or by setting the WDT_AO Flash Option Bit. The WDT_AO bit forces the Watchdog Timer to operate immediately upon reset, even if a WDT instruction has not been executed.

The Watchdog Timer is a 24-bit reloadable downcounter that uses three 8-bit registers in the eZ8 CPU register space to set the reload value. The nominal WDT time-out period is described by the following equation:

$$\text{WDT Time-out Period (ms)} = \frac{\text{WDT Reload Value}}{10}$$

where the WDT reload value is the decimal value of the 24-bit value given by {WDTU[7:0], WDTM[7:0], WDTL[7:0]} and the typical Watchdog Timer RC oscillator frequency is 10 kHz. The Watchdog Timer cannot be refreshed after it reaches 000002H. The WDT Reload Value must not be set to values below 000004H. [Table 56](#) provides information about approximate time-out delays for the minimum and maximum WDT reload values.

Table 56. Watchdog Timer Approximate Time-Out Delays

WDT Reload Value (Hex)	WDT Reload Value (Decimal)	Approximate Time-Out Delay (with 10 kHz typical WDT oscillator frequency)	
		Typical	Description
000004	4	400 μ s	Minimum time-out delay
FFFFFF	16,777,215	28 minutes	Maximum time-out delay

UART Address Compare Register

The UART Address Compare (UxADDR) register stores the multi-node network address of the UART (see [Table 67](#)). When the MPMD[1] bit of UART Control Register 0 is set, all incoming address bytes are compared to the value stored in the Address Compare register. Receive interrupts and RDA assertions only occur in the event of a match.

Table 67. UART Address Compare Register (U0ADDR)

BITS	7	6	5	4	3	2	1	0
FIELD	COMP_ADDR							
RESET	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
ADDR	F45H							

COMP_ADDR—Compare Address
This 8-bit value is compared to incoming address bytes.

UART Baud Rate High and Low Byte Registers

The UART Baud Rate High (UxBRH) and Low Byte (UxBRL) registers ([Table 68](#) and [Table 69](#)) combine to create a 16-bit baud rate divisor value (BRG[15:0]) that sets the data transmission rate (baud rate) of the UART.

Table 68. UART Baud Rate High Byte Register (U0BRH)

BITS	7	6	5	4	3	2	1	0
FIELD	BRH							
RESET	1	1	1	1	1	1	1	1
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
ADDR	F46H							

Table 69. UART Baud Rate Low Byte Register (U0BRL)

BITS	7	6	5	4	3	2	1	0
FIELD	BRL							
RESET	1	1	1	1	1	1	1	1
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
ADDR	F47H							

Assuming a compensated ADC measurement, the following equation defines the relationship between the ADC reading and the die temperature:

$$T = (25/128) \times (ADC - TSCAL[11:2]) + 30$$

where, T is the temperature in C; ADC is the 10-bit compensated ADC value; and TSCAL is the temperature sensor calibration value, ignoring the two least significant bits of the 12-bit value.

See [Temperature Sensor Calibration Data](#) on page 164 for the location of TSCAL.

Calibration

The temperature sensor undergoes calibration during the manufacturing process and is maximally accurate at 30 °C. Accuracy decreases as measured temperatures move further from the calibration point.

Operation

The Flash Controller programs and erases Flash memory. The Flash Controller provides the proper Flash controls and timing for Byte Programming, Page Erase, and Mass Erase of Flash memory.

The Flash Controller contains several protection mechanisms to prevent accidental programming or erasure. These mechanisms operate on the page, sector and full-memory levels.

The Flow Chart in [Figure 22](#) displays basic Flash Controller operation. The following subsections provide details about the various operations (Lock, Unlock, Byte Programming, Page Protect, Page Unprotect, Page Select, Page Erase, and Mass Erase) displayed in [Figure 22](#).

Table 100. Serialization Data Locations

Info Page Address	Memory Address	Usage
1C	FE1C	Serial Number Byte 3 (most significant)
1D	FE1D	Serial Number Byte 2
1E	FE1E	Serial Number Byte 1
1F	FE1F	Serial Number Byte 0 (least significant)

Randomized Lot Identifier

Table 101. Lot Identification Number (RAND_LOT)

BITS	7	6	5	4	3	2	1	0
FIELD	RAND_LOT							
RESET	U	U	U	U	U	U	U	U
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
ADDR	Interspersed throughout Information Page Memory							
Note: U = Unchanged by Reset. R/W = Read/Write.								

RAND_LOT—Randomized Lot ID

The randomized lot ID is a 32 byte binary value that changes for each production lot.

Table 102. Randomized Lot ID Locations

Info Page Address	Memory Address	Usage
3C	FE3C	Randomized Lot ID Byte 31 (most significant)
3D	FE3D	Randomized Lot ID Byte 30
3E	FE3E	Randomized Lot ID Byte 29
3F	FE3F	Randomized Lot ID Byte 28
58	FE58	Randomized Lot ID Byte 27
59	FE59	Randomized Lot ID Byte 26
5A	FE5A	Randomized Lot ID Byte 25
5B	FE5B	Randomized Lot ID Byte 24

Figure 29 displays the typical (3.3 V and 25 °C) oscillator frequency as a function of the capacitor (C in pF) employed in the RC network assuming a 45 K Ω external resistor. For very small values of C , the parasitic capacitance of the oscillator XIN pin and the printed circuit board must be included in the estimation of the oscillator frequency.

It is possible to operate the RC oscillator using only the parasitic capacitance of the package and printed circuit board. To minimize sensitivity to external parasitics, external capacitance values in excess of 20 pF are recommended.

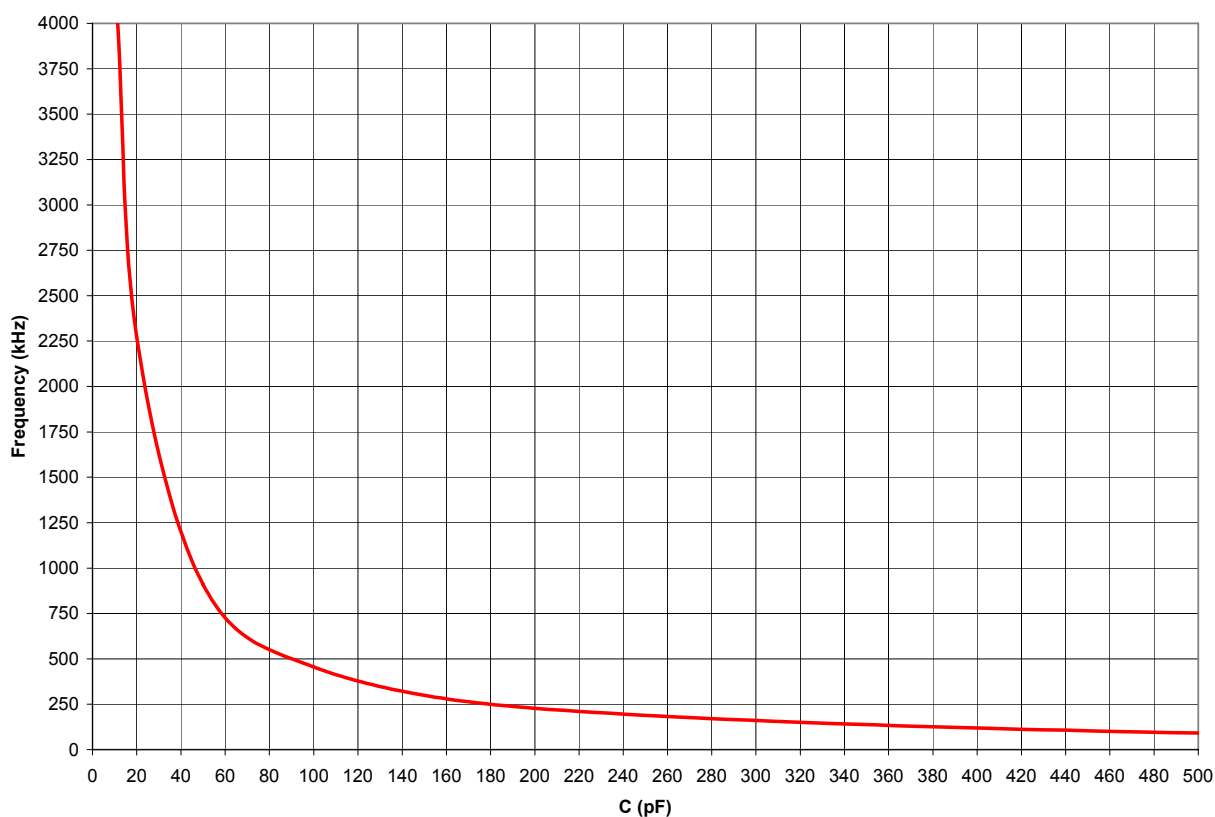


Figure 29. Typical RC Oscillator Frequency as a Function of the External Capacitance with a 45 k Ω Resistor



Caution:

When using the external RC oscillator mode, the oscillator can stop oscillating if the power supply drops below 2.7 V, but before the power supply drops to the Voltage Brownout threshold. The oscillator resumes oscillation when the supply voltage exceeds 2.7 V.

Table 124. eZ8 CPU Instruction Summary (Continued)

Assembly Mnemonic	Symbolic Operation	Address Mode		Opcode(s) (Hex)	Flags						Fetch Cycles	Instr. Cycles
		dst	src		C	Z	S	V	D	H		
AND dst, src	$\text{dst} \leftarrow \text{dst AND src}$	r	r	52	–	*	*	0	–	–	2	3
		r	lr	53							2	4
		R	R	54							3	3
		R	IR	55							3	4
		R	IM	56							3	3
		IR	IM	57							3	4
ANDX dst, src	$\text{dst} \leftarrow \text{dst AND src}$	ER	ER	58	–	*	*	0	–	–	4	3
		ER	IM	59							4	3
ATM	Block all interrupt and DMA requests during execution of the next 3 instructions			2F	–	–	–	–	–	–	1	2
BCLR bit, dst	$\text{dst}[\text{bit}] \leftarrow 0$	r		E2	–	–	–	–	–	–	2	2
BIT p, bit, dst	$\text{dst}[\text{bit}] \leftarrow p$	r		E2	–	–	–	–	–	–	2	2
BRK	Debugger Break			00	–	–	–	–	–	–	1	1
BSET bit, dst	$\text{dst}[\text{bit}] \leftarrow 1$	r		E2	–	–	–	–	–	–	2	2
BSWAP dst	$\text{dst}[7:0] \leftarrow \text{dst}[0:7]$	R		D5	X	*	*	0	–	–	2	2
BTJ p, bit, src, dst	if $\text{src}[\text{bit}] = p$ $\text{PC} \leftarrow \text{PC} + X$		r	F6	–	–	–	–	–	–	3	3
			lr	F7							3	4
BTJNZ bit, src, dst	if $\text{src}[\text{bit}] = 1$ $\text{PC} \leftarrow \text{PC} + X$		r	F6	–	–	–	–	–	–	3	3
			lr	F7							3	4
BTJZ bit, src, dst	if $\text{src}[\text{bit}] = 0$ $\text{PC} \leftarrow \text{PC} + X$		r	F6	–	–	–	–	–	–	3	3
			lr	F7							3	4
CALL dst	$\text{SP} \leftarrow \text{SP} - 2$ $@\text{SP} \leftarrow \text{PC}$ $\text{PC} \leftarrow \text{dst}$	IRR		D4	–	–	–	–	–	–	2	6
		DA		D6							3	3
CCF	$C \leftarrow \sim C$			EF	*	–	–	–	–	–	1	2
CLR dst	$\text{dst} \leftarrow 00H$	R		B0	–	–	–	–	–	–	2	2
		IR		B1							2	3
Flags Notation:	* = Value is a function of the result of the operation. – = Unaffected X = Undefined				0 = Reset to 0 1 = Set to 1							

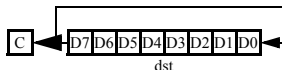
Table 124. eZ8 CPU Instruction Summary (Continued)

Assembly Mnemonic	Symbolic Operation	Address Mode		Opcode(s) (Hex)	Flags						Fetch Cycles	Instr. Cycles
		dst	src		C	Z	S	V	D	H		
COM dst	dst ← ~dst	R		60	–	*	*	0	–	–	2	2
		IR		61							2	3
CP dst, src	dst - src	r	r	A2	*	*	*	*	–	–	2	3
		r	lr	A3							2	4
		R	R	A4							3	3
		R	IR	A5							3	4
		R	IM	A6							3	3
		IR	IM	A7							3	4
CPC dst, src	dst - src - C	r	r	1F A2	*	*	*	*	–	–	3	3
		r	lr	1F A3							3	4
		R	R	1F A4							4	3
		R	IR	1F A5							4	4
		R	IM	1F A6							4	3
		IR	IM	1F A7							4	4
CPCX dst, src	dst - src - C	ER	ER	1F A8	*	*	*	*	–	–	5	3
		ER	IM	1F A9							5	3
CPX dst, src	dst - src	ER	ER	A8	*	*	*	*	–	–	4	3
		ER	IM	A9							4	3
DA dst	dst ← DA(dst)	R		40	*	*	*	X	–	–	2	2
		IR		41							2	3
DEC dst	dst ← dst - 1	R		30	–	*	*	*	–	–	2	2
		IR		31							2	3
DECW dst	dst ← dst - 1	RR		80	–	*	*	*	–	–	2	5
		IRR		81							2	6
DI	IRQCTL[7] ← 0			8F	–	–	–	–	–	–	1	2
DJNZ dst, RA	dst ← dst - 1 if dst ≠ 0 PC ← PC + X	r		0A-FA	–	–	–	–	–	–	2	3
EI	IRQCTL[7] ← 1			9F	–	–	–	–	–	–	1	2
Flags Notation:	* = Value is a function of the result of the operation. – = Unaffected X = Undefined				0 = Reset to 0 1 = Set to 1							

Table 124. eZ8 CPU Instruction Summary (Continued)

Assembly Mnemonic	Symbolic Operation	Address Mode		Opcode(s) (Hex)	Flags						Fetch Cycles	Instr. Cycles
		dst	src		C	Z	S	V	D	H		
LDC dst, src	$\text{dst} \leftarrow \text{src}$	r	lrr	C2	–	–	–	–	–	–	2	5
		lr	lrr	C5							2	9
		lrr	r	D2							2	5
LDCI dst, src	$\text{dst} \leftarrow \text{src}$ $r \leftarrow r + 1$ $rr \leftarrow rr + 1$	lr	lrr	C3	–	–	–	–	–	–	2	9
		lrr	lr	D3							2	9
LDE dst, src	$\text{dst} \leftarrow \text{src}$	r	lrr	82	–	–	–	–	–	–	2	5
		lrr	r	92							2	5
LDEI dst, src	$\text{dst} \leftarrow \text{src}$ $r \leftarrow r + 1$ $rr \leftarrow rr + 1$	lr	lrr	83	–	–	–	–	–	–	2	9
		lrr	lr	93							2	9
LDWX dst, src	$\text{dst} \leftarrow \text{src}$	ER	ER	1FE8	–	–	–	–	–	–	5	4
LDX dst, src	$\text{dst} \leftarrow \text{src}$	r	ER	84	–	–	–	–	–	–	3	2
		lr	ER	85							3	3
		R	IRR	86							3	4
		IR	IRR	87							3	5
		r	X(rr)	88							3	4
		X(rr)	r	89							3	4
		ER	r	94							3	2
		ER	lr	95							3	3
		IRR	R	96							3	4
		IRR	IR	97							3	5
		ER	ER	E8							4	2
		ER	IM	E9							4	2
LEA dst, X(src)	$\text{dst} \leftarrow \text{src} + X$	r	X(r)	98	–	–	–	–	–	–	3	3
		rr	X(rr)	99							3	5
MULT dst	$\text{dst}[15:0] \leftarrow \text{dst}[15:8] * \text{dst}[7:0]$	RR		F4	–	–	–	–	–	–	2	8
NOP	No operation			0F	–	–	–	–	–	–	1	2
Flags Notation:	* = Value is a function of the result of the operation. – = Unaffected X = Undefined				0 = Reset to 0 1 = Set to 1							

Table 124. eZ8 CPU Instruction Summary (Continued)

Assembly Mnemonic	Symbolic Operation	Address Mode		Opcode(s) (Hex)	Flags						Fetch Cycles	Instr. Cycles
		dst	src		C	Z	S	V	D	H		
OR dst, src	dst ← dst OR src	r	r	42	–	*	*	0	–	–	2	3
		r	lr	43							2	4
		R	R	44							3	3
		R	IR	45							3	4
		R	IM	46							3	3
		IR	IM	47							3	4
ORX dst, src	dst ← dst OR src	ER	ER	48	–	*	*	0	–	–	4	3
		ER	IM	49							4	3
POP dst	dst ← @SP SP ← SP + 1	R		50	–	–	–	–	–	–	2	2
		IR		51							2	3
POPX dst	dst ← @SP SP ← SP + 1	ER		D8	–	–	–	–	–	–	3	2
PUSH src	SP ← SP – 1 @SP ← src	R		70	–	–	–	–	–	–	2	2
		IR		71							2	3
		IM		IF70							3	2
PUSHX src	SP ← SP – 1 @SP ← src	ER		C8	–	–	–	–	–	–	3	2
RCF	C ← 0			CF	0	–	–	–	–	–	1	2
RET	PC ← @SP SP ← SP + 2			AF	–	–	–	–	–	–	1	4
RL dst		R		90	*	*	*	*	–	–	2	2
		IR		91								2
RLC dst		R		10	*	*	*	*	–	–	2	2
		IR		11								2
Flags Notation:	* = Value is a function of the result of the operation. – = Unaffected X = Undefined				0 = Reset to 0 1 = Set to 1							

Electrical Characteristics

The data in this chapter is pre-qualification and pre-characterization and is subject to change. Additional electrical characteristics may be found in the individual chapters.

Absolute Maximum Ratings

Stresses greater than those listed in [Table 126](#) may cause permanent damage to the device. These ratings are stress ratings only. Operation of the device at any condition outside those indicated in the operational sections of these specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. For improved reliability, tie unused inputs to one of the supply voltages (V_{DD} or V_{SS}).

Table 126. Absolute Maximum Ratings

Parameter	Minimum	Maximum	Units	Notes
Ambient temperature under bias	-40	+105	°C	
Storage temperature	-65	+150	°C	
Voltage on any pin with respect to V_{SS}	-0.3	+5.5	V	1
	-0.3	+3.9	V	2
Voltage on V_{DD} pin with respect to V_{SS}	-0.3	+3.6	V	
Maximum current on input and/or inactive output pin	-5	+5	μA	
Maximum output current from active output pin	-25	+25	mA	
8-pin Packages Maximum Ratings at 0 °C to 70 °C				
Total power dissipation		220	mW	
Maximum current into V_{DD} or out of V_{SS}		60	mA	
20-pin Packages Maximum Ratings at 0 °C to 70 °C				
Total power dissipation		430	mW	
Maximum current into V_{DD} or out of V_{SS}		120	mA	

Table 138. Temperature Sensor Electrical Characteristics

Symbol	Parameter	V _{DD} = 2.7 V to 3.6 V			Units	Conditions
		Minimum	Typical	Maximum		
T _{AERR}	Temperature Error		±0.5	±2	°C	Over the range +20 °C to +30 °C (as measured by ADC) ¹
			±1	±5	°C	Over the range +0 °C to +70 °C (as measured by ADC)
			±2	±7	°C	Over the range +0 °C to +105 °C (as measured by ADC)
			±7		°C	Over the range -40 °C to +105 °C (as measured by ADC)
T _{AERR}	Temperature Error		TBD		°C	Over the range -40 °C to +105 °C (as measured by comparator)
t _{WAKE}	Wakeup Time		80	100	μs	Time required for Temperature Sensor to stabilize after enabling

¹Devices are factory calibrated at for maximal accuracy between +20 °C and +30 °C, so the sensor is maximally accurate in that range. User re-calibration for a different temperature range is possible and increases accuracy near the new calibration point.

General Purpose I/O Port Input Data Sample Timing

Figure 34 displays timing of the GPIO Port input sampling. The input value on a GPIO Port pin is sampled on the rising edge of the system clock. The Port value is available to the eZ8 CPU on the second rising clock edge following the change of the Port value.

Figure 47 displays the 28-pin Small Shrink Outline Package (SSOP) available for the Z8 Encore! XP F082A Series devices.

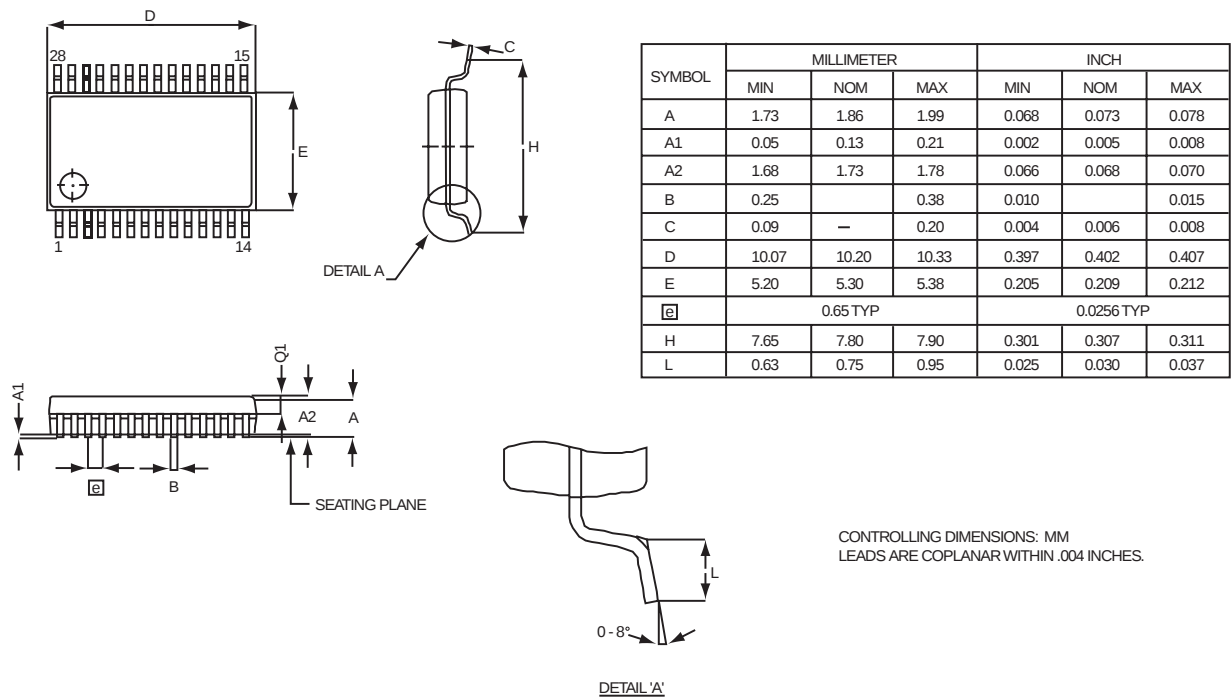


Figure 47. 28-Pin Small Shrink Outline Package (SSOP)

Part Number	Flash	RAM	NVDS	I/O Lines	Interrupts	16-Bit Timers w/PWM	10-Bit A/D Channels	UART with IrDA	Comparator	Temperature Sensor	Description
Z8 Encore! XP[®] F082A Series with 2 KB Flash, 10-Bit Analog-to-Digital Converter											
Standard Temperature: 0 °C to 70 °C											
Z8F022APB020SC	2 KB	512 B	64 B	6	14	2	4	1	1	1	PDIP 8-pin package
Z8F022AQB020SC	2 KB	512 B	64 B	6	14	2	4	1	1	1	QFN 8-pin package
Z8F022ASB020SC	2 KB	512 B	64 B	6	14	2	4	1	1	1	SOIC 8-pin package
Z8F022ASH020SC	2 KB	512 B	64 B	17	20	2	7	1	1	1	SOIC 20-pin package
Z8F022AHH020SC	2 KB	512 B	64 B	17	20	2	7	1	1	1	SSOP 20-pin package
Z8F022APH020SC	2 KB	512 B	64 B	17	20	2	7	1	1	1	PDIP 20-pin package
Z8F022ASJ020SC	2 KB	512 B	64 B	23	20	2	8	1	1	1	SOIC 28-pin package
Z8F022AHJ020SC	2 KB	512 B	64 B	23	20	2	8	1	1	1	SSOP 28-pin package
Z8F022APJ020SC	2 KB	512 B	64 B	23	20	2	8	1	1	1	PDIP 28-pin package
Extended Temperature: -40 °C to 105 °C											
Z8F022APB020EC	2 KB	512 B	64 B	6	14	2	4	1	1	1	PDIP 8-pin package
Z8F022AQB020EC	2 KB	512 B	64 B	6	14	2	4	1	1	1	QFN 8-pin package
Z8F022ASB020EC	2 KB	512 B	64 B	6	14	2	4	1	1	1	SOIC 8-pin package
Z8F022ASH020EC	2 KB	512 B	64 B	17	20	2	7	1	1	1	SOIC 20-pin package
Z8F022AHH020EC	2 KB	512 B	64 B	17	20	2	7	1	1	1	SSOP 20-pin package
Z8F022APH020EC	2 KB	512 B	64 B	17	20	2	7	1	1	1	PDIP 20-pin package
Z8F022ASJ020EC	2 KB	512 B	64 B	23	20	2	8	1	1	1	SOIC 28-pin package
Z8F022AHJ020EC	2 KB	512 B	64 B	23	20	2	8	1	1	1	SSOP 28-pin package
Z8F022APJ020EC	2 KB	512 B	64 B	23	20	2	8	1	1	1	PDIP 28-pin package
Replace C with G for Lead-Free Packaging											